# **ESP8285**

### **Datasheet**

### **Related Product:**

ESP8285N08

ESP8285H16

### Note:

It is recommended to use the upgraded model: <u>ESP8684</u>



# **About This Guide**

This document introduces the specifications of ESP8285.

### **Release Notes**

2016.04       V1.0       First release.         2016.11       V1.1       Added Appendix B "Learning Resources".         2017.01       V1.2       • Changed the power consumption during Deep-sleep from 10 μA to 20 μA in Table 5-2.         2017.01       V1.2       • Changed the crystal frequency range from "26 MHz to 52 MHz" to "24 MHz to 52 MHz" in Section 3.3.         2017.05       V1.3       Changed the chip's input impedance of 50Ω to output impedance of 39+j6 Ω.         2017.11       V1.4       Updated Chapter 3 regarding the range of clock amplitude to 0.8 ~ 1.5V; Updated the range of VDDPST to 2.7 ~ 3.6V.         2018.04       V1.5       • Added a note in Chapter 2; Updated description about CPU in Section 3.1.1.         2018.04       V1.5       • Added a note for Table 1-1; Updated description of the Wi-Fi function in 3.5; Updated description in Jayout diagram; Fixed a typo in Table 2-1; Pixed a typo in Table 2-1; Removed Section AHB and AHB module; Restructured Section Power Management; Fixed a typo in Section UART; Removed description of transmission angle in Section IR Remote Control; Added a SPI pin in Table 4-2; Updated the diagram of packing information; Other optimization (wording).         2019.07       V1.7       Updated Tigure 2-1 to adjust the location of Pin 33; Updated description for rew variants; Updated the values of some technical parameters.         2019.08       V1.8       Removed description of the GPIO function in Section 4.1.	Date	Version	Release notes			
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Date	Version	Release notes
2019.08	V1.9	Updated notes on CHIP_EN in Section 5.1
2019.12	V2.0	Add feedback links.
2020.03	V2.1	<ul><li>Removed the description of "Antenna diversity";</li><li>Updated the feedback links.</li></ul>
2020.07	V2.2	<ul><li>Updated the description of HSPI in Section 4.3;</li><li>Updated links in Appendix.</li></ul>
2021.09	V2.3	Removed all the contents related to ESP8285H08.
2022.10	V2.4	Updated typos in Chapter 6.
2023.02	v2.5	Added link to Xtensa® Instruction Set Architecture (ISA) Summary in Section 3.1.1.
2023.06	v2.6	<ul><li>Added a note on the cover page;</li><li>Updated two documents in Appendix.</li></ul>

### **Documentation Change Notification**

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### 1.

## Overview

Espressif's ESP8285 delivers highly integrated Wi-Fi SoC solution to meet users' continuous demands for efficient power usage, compact design and reliable performance in the Internet of Things industry.

With the complete and self-contained Wi-Fi networking capabilities, ESP8285 can perform either as a standalone application or as the slave to a host MCU. When ESP8285 hosts the application, it promptly boots up from the flash. The integrated high-speed cache helps to increase the system performance and optimize the system memory. Also, ESP8285 can be applied to any microcontroller design as a Wi-Fi adaptor through SPI/SDIO or UART interfaces.

ESP8285 integrates antenna switches, RF balun, power amplifier, low noise receive amplifier, filters and power management modules. The compact design minimizes the PCB size and requires minimal external circuitries.

Besides the Wi-Fi functionalities, ESP8285 also integrates an enhanced version of Tensilica's L106 Diamond series 32-bit processor and on-chip SRAM. It can be interfaced with external sensors and other devices through the GPIOs. Software Development Kit (SDK) provides sample codes for various applications.

Espressif Systems' Smart Connectivity Platform (ESCP) enables sophisticated features including:

- Fast switch between sleep and wakeup mode for energy-efficient purpose
- Adaptive radio biasing for low-power operation
- Advance signal processing
- Spur cancellation and RF co-existence mechanisms for common cellular, Bluetooth, DDR, LVDS, LCD interference mitigation

To provide more options for customers with different requirements for memory and operating temperature, Espressif provides two different models in ESP8285 family. For details, please see below:

Table 1-1. ESP8285 family

Model	Memory	Operating Temperature
ESP8285N08	1 MB	-40 °C ~ 85 °C
ESP8285H16	2 MB	-40 °C ~ 105 °C



### 1.1. Wi-Fi Key Features

- 802.11 b/g/n support
- 802.11n support (2.4 GHz), up to 72.2 Mbps
- Defragmentation
- 2 x virtual Wi-Fi interface
- Automatic beacon monitoring (hardware TSF)
- Support Infrastructure BSS Station mode/SoftAP mode/Promiscuous mode

### 1.2. Specifications

Table 1-2. Specifications

Items	Parameters		
Protocols	802.11 b/g/n (HT20)		
Frequency Range	2400 MHz ~ 2483.5 MHz		
	802.11 b: +19 dBm		
	802.11 g: +19 dBm (6 Mbps)		
TX Power <sup>①</sup>	802.11 g: +15 dBm (54 Mbps)		
	802.11 n: +19 dBm (MCS0)		
	802.11 n: +14 dBm (MCS7)		
	802.11 b: -97 dBm (1 Mbps)		
Rx Sensitivity	802.11 g: -74 dBm (54 Mbps)		
	802.11 n: -70 dBm (MCS7)		
Antenna	PCB Trace, External, IPEX Connector, Ceramic Chip		
CPU	Tensilica L106 32-bit processor		
Dovinhoval Interfere	UART/SDIO/SPI/I2C/I2S/IR Remote Control		
Реприетан интегласе	GPIO/ADC/PWM/LED Light & Button		
Operating Voltage	2.7 V ~ 3.6 V		
Operating Current	Average value: 80 mA		
Package Size	QFN32-pin (5 mm x 5 mm)		
External Interface	-		
Wi-Fi Mode	Station/SoftAP/SoftAP+Station		
Security	WPA/WPA2		
Encryption	WEP/TKIP/AES		
	Protocols  Frequency Range  TX Power®  Rx Sensitivity  Antenna  CPU  Peripheral Interface  Operating Voltage  Operating Current  Package Size  External Interface  Wi-Fi Mode  Security		



Categories	Items	Parameters		
0.0	Firmware Upgrade	UART Download / OTA (via network)		
Software	Software Development	Supports Cloud Server Development / Firmware and SDK for fast on-chip programming		
	Network Protocols <sup>©</sup>	IPv4/IPv6, TCP/UDP, SSL/MQTT/HTTP/HTTPS/mDNS/CoAP		
	User Configuration	AT Instruction Set, Cloud Server, Android/iOS App		

#### Note:

- 1 The TX power can be configured based on the actual user scenarios.
- ② The network protocols are provided within the ESP8266\_RTOS\_SDK SDK. The link to this SDK is <a href="https://github.com/espressif/ESP8266\_RTOS\_SDK">https://github.com/espressif/ESP8266\_RTOS\_SDK</a>.

### 1.3. Applications

- Home appliances
- Home automation
- Smart plugs and lights
- Industrial wireless control
- Baby monitors
- IP cameras
- Sensor networks
- Wearable electronics
- Wi-Fi location-aware devices
- Security ID tags
- Wi-Fi position system beacons



### 2.

# **Pin Definitions**

Figure 2-1 shows the pin layout for 32-pin QFN package.

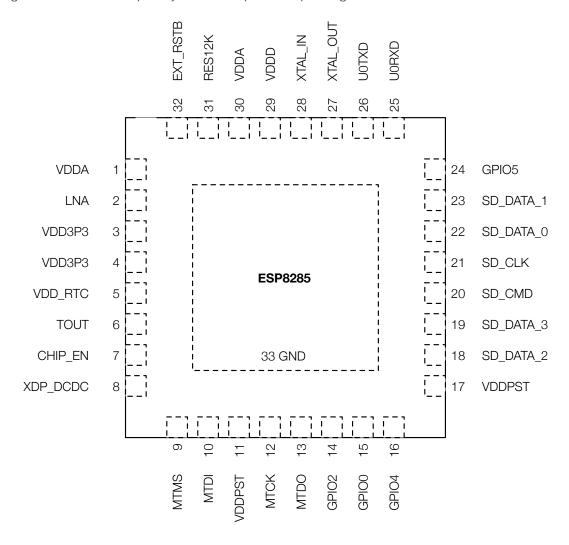


Figure 2-1. Pin Layout (Top View)

Table 2-1 lists the definitions and functions of each pin.

Table 2-1. ESP8285EX Pin Definitions

Pin	Name	Туре	Function
1	VDDA	Р	Analog Power 2.5 V ~ 3.6 V
2	LNA	I/O	RF antenna interface $ \text{Chip output impedance} = 39 + \text{j6 }\Omega. \text{ It is suggested to retain the $\pi$-type matching network to match the antenna.} $



Pin	Name	Туре	Function	
3	VDD3P3	Р	Amplifier Power 2.5 V ~ 3.6 V	
4	VDD3P3	Р	Amplifier Power 2.5 V ~ 3.6 V	
5	VDD_RTC	Р	NC (1.1 V)	
6	TOUT	I	ADC pin. It can be used to test the power-supply voltage of VDD3P3 (Pin3 and Pin4) and the input power voltage of TOUT (Pin 6). However, these two functions cannot be used simultaneously.	
7	CHIP_EN	I	Chip Enable High: On, chip works properly Low: Off, small current consumed	
8	XPD_DCDC	I/O	Deep-sleep wakeup (need to be connected to EXT_RSTB); GPIO16	
9	MTMS	I/O	GPIO 14; HSPI_CLK	
10	MTDI	I/O	GPIO 12; HSPI_MISO	
11	VDDPST	Р	Digital/IO Power Supply (2.7 V ~ 3.6 V)	
12	MTCK	I/O	GPIO 13; HSPI_MOSI; UARTO_CTS	
13	MTDO	I/O	GPIO 15; HSPI_CS; UART0_RTS	
14	GPIO2	I/O	UART TX during flash programming; GPIO2	
15	GPI00	I/O	GPIO0; SPI_CS2	
16	GPIO4	I/O	GPIO4	
17	VDDPST	Р	Digital/IO Power Supply (2.7 V ~ 3.6 V)	
18	SDIO_DATA_2	I/O	Connect to SD_D2 (Series R: 200Ω); SPIHD; HSPIHD; GPIO9	
19	SDIO_DATA_3	I/O	Connect to SD_D3 (Series R: $200\Omega$ ); SPIWP; HSPIWP; GPIO10	
20	SDIO_CMD	I/O	Connect to SD_CMD (Series R: 200Ω); SPI_CS0; GPIO11	
21	SDIO_CLK	I/O	Connect to SD_CLK (Series R: 200Ω); SPI_CLK; GPIO6	
22	SDIO_DATA_0	I/O	Connect to SD_D0 (Series R: 200Ω); SPI_MISO; GPIO7	
23	SDIO_DATA_1	I/O	Connect to SD_D1 (Series R: 200Ω); SPI_MOSI; GPIO8	
24	GPIO5	I/O	GPIO5	
25	UORXD	I/O	UART Rx during flash programming; GPIO3	
26	UOTXD	I/O	UART TX during flash programming; GPIO1; SPI_CS1	
27	XTAL_OUT	I/O	Connect to crystal oscillator output, can be used to provide BT clock input	
28	XTAL_IN	I/O	Connect to crystal oscillator input	
29	VDDD	Р	Analog Power 2.5 V ~ 3.6 V	



Pin	Name	Туре	Function
30	VDDA	Р	Analog Power 2.5 V ~ 3.6 V
31	RES12K	1	Serial connection with a 12 $k\Omega$ resistor and connect to the ground
32	EXT_RSTB	I	External reset signal (Low voltage level: active)

#### Note:

- 1. GPIO2, GPIO0, and MTDO are used to select booting mode and the SDIO mode;
- 2. ESP8285's pins SDIO\_CMD, SDIO\_CLK, SDIO\_DATA\_0 and SDIO\_DATA\_1 are used for connecting the embedded flash, and are not recommended for other uses;
- 3. UOTXD should not be pulled externally to a low logic level during the powering-up.



# 3. Functional Description

The functional diagram of ESP8285 is shown as in Figure 3-1.

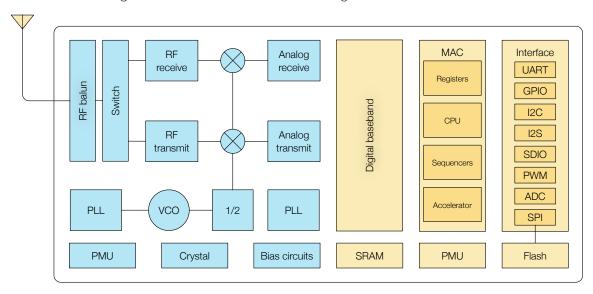


Figure 3-1. Functional Block Diagram

### 3.1. CPU, Memory, and Flash

### 3.1.1. CPU

The ESP8285 integrates a Tensilica L106 32-bit RISC processor, which achieves extra-low power consumption and reaches a maximum clock speed of 160 MHz. The Real-Time Operating System (RTOS) and Wi-Fi stack allow 80% of the processing power to be available for user application programming and development. The CPU includes the interfaces as below:

- Programmable RAM/ROM interfaces (iBus), which can be connected with memory controller, and can also be used to visit flash.
- Data RAM interface (dBus), which can connected with memory controller.
- AHB interface which can be used to visit the register.

For information about the Xtensa® Instruction Set Architecture, please refer to <u>Xtensa®</u> Instruction Set Architecture (ISA) Summary.

### 3.1.2. Memory

ESP8285 Wi-Fi SoC integrates memory controller and memory units including SRAM and ROM. MCU can access the memory units through iBus, dBus, and AHB interfaces. All memory units can be accessed upon request, while a memory arbiter will decide the



running sequence according to the time when these requests are received by the processor.

According to our latest version of RTOS SDK, the SRAM space (Heap + Data) available to users is less than 75 kB when ESP8285 is working under the Station mode and connects to the router.

#### Note:

The remaining SRAM space is measured with the ESP8266\_RTOS\_SDK SDK. The link to this SDK is <a href="https://github.com/espressif/ESP8266\_RTOS\_SDK">https://github.com/espressif/ESP8266\_RTOS\_SDK</a>.

#### 3.1.3. Flash

ESP8285 has a built-in SPI flash to store user programs.

• Memory size: see Table 1-1.

SPI mode: Dual SPI

### 3.2. Clock

### 3.2.1. High Frequency Clock

The high frequency clock on ESP8285 is used to drive both transmit and receive mixers. This clock is generated from internal crystal oscillator and external crystal. The crystal frequency ranges from 24 MHz to 52 MHz.

The internal calibration inside the crystal oscillator ensures that a wide range of crystals can be used, nevertheless the quality of the crystal is still a factor to consider to have reasonable phase noise and good Wi-Fi sensitivity. Refer to Table 3-1 to measure the frequency offset.

**Parameter** Symbol Min Max Unit FXO 24 52 MHz Frequency Loading capacitance CL 32 рF рF Motional capacitance CM 2 5 Series resistance RS  $\cap$ 65  $\bigcirc$  $\Delta \text{FXO}$ Frequency tolerance -15 15 ppm Frequency vs temperature (-25 °C ~ 75 °C) ΔFXO,Temp -1515 ppm

Table 3-1. High Frequency Clock Specifications

### 3.2.2. External Clock Requirements

An externally generated clock is available with the frequency ranging from 24 MHz to 52 MHz. The following characteristics are expected to achieve good performance of radio.



Table 3-2. External Clock Reference

Parameter	Symbol	Min	Max	Unit
Clock amplitude	VXO	0.8	1.5	Vpp
External clock accuracy	ΔFXO,EXT	-15	15	ppm
Phase noise @1 kHz offset, 40 MHz clock	-	-	-120	dBc/Hz
Phase noise @10 kHz offset, 40 MHz clock	-	-	-130	dBc/Hz
Phase noise @100 kHz offset, 40 MHz clock	-	-	-138	dBc/Hz

### 3.3. Radio

ESP8285 radio consists of the following blocks.

- 2.4 GHz receiver
- 2.4 GHz transmitter
- High speed clock generators and crystal oscillator
- Bias and regulators
- Power management

### 3.3.1. Channel Frequencies

The RF transceiver supports the following channels according to IEEE802.11b/g/n standards.

Table 3-3. Frequency Channel

Channel No.	Frequency (MHz)	Channel No.	Frequency (MHz)
1	2412	8	2447
2	2417	9	2452
3	2422	10	2457
4	2427	11	2462
5	2432	12	2467
6	2437	13	2472
7	2442	14	2484

#### 3.3.2. 2.4 GHz Receiver

The 2.4 GHz receiver down-converts the RF signals to quadrature baseband signals and converts them to the digital domain with 2 high resolution high speed ADCs. To adapt to



varying signal channel conditions, RF filters, automatic gain control (AGC), DC offset cancelation circuits and baseband filters are integrated within ESP8285.

### 3.3.3. 2.4 GHz Transmitter

The 2.4 GHz transmitter up-converts the quadrature baseband signals to 2.4 GHz, and drives the antenna with a high-power CMOS power amplifier. The function of digital calibration further improves the linearity of the power amplifier, enabling a state of art performance of delivering +19 dBm average TX power for 802.11b transmission and +19 dBm for 802.11 n (MSC0) transmission.

Additional calibrations are integrated to offset any imperfections of the radio, such as:

- Carrier leakage
- I/Q phase matching
- · Baseband nonlinearities

These built-in calibration functions reduce the product test time and make the test equipment unnecessary.

#### 3.3.4. Clock Generator

The clock generator generates quadrature 2.4 GHz clock signals for the receiver and transmitter. All components of the clock generator are integrated on the chip, including all inductors, varactors, loop filters, linear voltage regulators and dividers.

The clock generator has built-in calibration and self test circuits. Quadrature clock phases and phase noise are optimized on-chip with patented calibration algorithms to ensure the best performance of the receiver and transmitter.

### 3.4. Wi-Fi

ESP8285 implements TCP/IP and full 802.11 b/g/n WLAN MAC protocol. It supports Basic Service Set (BSS) STA and SoftAP operations under the Distributed Control Function (DCF). Power management is handled with minimum host interaction to minimize active-duty period.

#### 3.4.1. Wi-Fi Radio and Baseband

The ESP8285 Wi-Fi Radio and Baseband support the following features:

- 802.11 b and 802.11 g
- 802.11 n MCS0-7 in 20 MHz bandwidth
- 802.11 n 0.4 µs guard-interval
- up to 72.2 Mbps of data rate
- Receiving STBC 2 x 1
- Adjustable transmitting power



#### 3.4.2. Wi-Fi MAC

The ESP8285 Wi-Fi MAC applies low-level protocol functions automatically, as follows:

- 2 × virtual Wi-Fi interfaces
- Infrastructure BSS Station mode/SoftAP mode/Promiscuous mode
- Request To Send (RTS), Clear To Send (CTS) and Immediate Block ACK
- Defragmentation
- CCMP (CBC-MAC, counter mode), TKIP (MIC, RC4), WEP (RC4) and CRC
- Automatic beacon monitoring (hardware TSF)
- Dual and single antenna Bluetooth co-existence support with optional simultaneous receive (Wi-Fi/Bluetooth) capability

### 3.5. Power Management

ESP8285 is designed with advanced power management technologies and intended for mobile devices, wearable electronics and the Internet of Things applications.

The low-power architecture operates in the following modes:

- Active mode: The chip radio is powered on. The chip can receive, transmit, or listen.
- Modem-sleep mode: The CPU is operational. The Wi-Fi and radio are disabled.
- Light-sleep mode: The CPU and all peripherals are paused. Any wake-up events (MAC, host, RTC timer, or external interrupts) will wake up the chip.
- Deep-sleep mode: Only the RTC is operational and all other part of the chip are powered off.

Table 3-4. Power Consumption by Power Modes

Power Mode	Description	Power Consumption	
Active (DE working)	Wi-Fi TX packet	Diagon refer to Table F 0	
Active (RF working)	Wi-Fi RX packet	Please refer to Table 5-2.	
Modem-sleep <sup>①</sup>	CPU is working	15 mA	
Light-sleep <sup>②</sup>	-	0.9 mA	
Deep-sleep <sup>®</sup>	Only RTC is working	20 uA	
Shut down	-	0.5 uA	



#### Notes:

- ① Modem-sleep mode is used in the applications that require the CPU to be working, as in PWM or I2S applications. According to 802.11 standards (like U-APSD), it shuts down the Wi-Fi Modem circuit while maintaining a Wi-Fi connection with no data transmission to optimize power consumption. E.g. in DTIM3, maintaining a sleep of 300 ms with a wakeup of 3 ms cycle to receive AP's Beacon packages at interval requires about 15 mA current.
- ② During **Light-sleep** mode, the CPU may be suspended in applications like Wi-Fi switch. Without data transmission, the Wi-Fi Modem circuit can be turned off and CPU suspended to save power consumption according to the 802.11 standards (U-APSD). E.g. in DTIM3, maintaining a sleep of 300 ms with a wakeup of 3ms to receive AP's Beacon packages at interval requires about 0.9 mA current.
- ③ During **Deep-sleep** mode, Wi-Fi is turned off. For applications with long time lags between data transmission, e.g. a temperature sensor that detects the temperature every 100 s, sleeps for 300 s and wakes up to connect to the AP (taking about 0.3 ~ 1 s), the overall average current is less than 1 mA. The current of 20 μA is acquired at the voltage of 2.5 V.



### 4.

# Peripheral Interface

### 4.1. General Purpose Input/Output Interface (GPIO)

ESP8285 has 17 GPIO pins which can be assigned to various functions by programming the appropriate registers.

Each GPIO PAD can be configured with internal pull-up or pull-down (XPD\_DCDC can only be configured with internal pull-down, other GPIO PAD can only be configured with internal pull-up), or set to high impedance. When configured as an input, the data are stored in software registers; the input can also be set to edge-trigger or level trigger CPU interrupts. In short, the IO pads are bi-directional, non-inverting and tristate, which includes input and output buffer with tristate control inputs.

These pins, when working as GPIOs, can be multiplexed with other functions such as I2C, I2S, UART, PWM, and IR Remote Control, etc.

### 4.2. Secure Digital Input/Output Interface (SDIO)

ESP8285 has one Slave SDIO, the definitions of which are described as Table 4-1, which supports 25 MHz SDIO v1.1 and 50 MHz SDIO v2.0, and 1 bit/4 bit SD mode and SPI mode.

Pin Name Pin Num 10 **Function Name** SDIO\_CLK 21 106 SDIO\_CLK SDIO DATAO 22 107 SDIO\_DATA0 SDIO DATA1 23 IO8 SDIO\_DATA1 SDIO\_DATA\_2 109 SDIO\_DATA\_2 18 SDIO\_DATA\_3 19 1010 SDIO\_DATA\_3 SDIO\_CMD 20 1011 SDIO\_CMD

Table 4-1. Pin Definitions of SDIOs



### 4.3. Serial Peripheral Interface (SPI/HSPI)

ESP8285 has two SPIs.

- One general Slave/Master SPI
- One general Slave/Master HSPI

Functions of all these pins can be implemented via hardware.

### 4.3.1. General SPI (Master/Slave)

Table 4-2. Pin Definitions of SPIs

Pin Name	Pin Num	Ю	Function Name
SDIO_CLK	21	106	SPICLK
SDIO_DATA0	22	107	SPIQ/MISO
SDIO_DATA1	23	IO8	SPID/MOSI
SDIO_DATA_2	18	109	SPIHD
SDIO_DATA_3	19	IO10	SPIWP
UOTXD	26	IO1	SPICS1
GPI00	15	IO0	SPICS2
SDIO_CMD	20	IO11	SPICS0

#### Note:

SPI mode can be implemented via software programming. The clock frequency is 80 MHz at maximum when working as a master, 20 MHz at maximum when working as a slave.

#### 4.3.2. HSPI (Master/Slave)

Table 4-3. Pin Definitions of HSPI

Pin Name	Pin Num	Ю	Function Name
MTMS	9	IO14	HSPICLK
MTDI	10	IO12	HSPIQ/MISO
MTCK	12	IO13	HSPID/MOSI
MTDO	13	IO15	HPSICS



SPI mode can be implemented via software programming. The clock frequency is 20 MHz at maximum.



### 4.4. I2C Interface

ESP8285 has one I2C, which is realized via software programming, used to connect with other microcontrollers and other peripheral equipments such as sensors. The pin definition of I2C is as below.

Table 4-4. Pin Definitions of I2C

Pin Name	Pin Num	Ю	Function Name
MTMS	9	IO14	I2C_SCL
GPIO2	14	IO2	I2C_SDA

Both I2C Master and I2C Slave are supported. I2C interface functionality can be realized via software programming, and the clock frequency is 100 kHz at maximum.

### 4.5. I2S Interface

ESP8285 has one I2S data input interface and one I2S data output interface, and supports the linked list DMA. I2S interfaces are mainly used in applications such as data collection, processing, and transmission of audio data, as well as the input and output of serial data. For example, LED lights (WS2812 series) are supported. The pin definition of I2S is shown in Table 4-5.

Table 4-5. Pin Definitions of I2S

I2S Data Input				
Pin Name	Pin Num	Ю	Function Name	
MTDI	10	IO12	I2SI_DATA	
MTCK	12	IO13	I2SI_BCK	
MTMS	9	IO14	12SI_WS	
MTDO	13	IO15	I2SO_BCK	
UORXD	25	IO3	I2SO_DATA	
GPIO2	14	102	12SO_WS	

### 4.6. Universal Asynchronous Receiver Transmitter (UART)

ESP8285 has two UART interfaces UART0 and UART1, the definitions are shown in Table 4-6.



Table 4-6. Pin Definitions of UART

Pin Type	Pin Name	Pin Num	10	Function Name
	U0RXD	25	IO3	UORXD
UART0	UOTXD	26	IO1	UOTXD
М	MTDO	13	IO15	UORTS
	MTCK	12	IO13	UOCTS
UART1	GPIO2	14	IO2	U1TXD
	SD_D1	23	IO8	U1RXD

Data transfers to/from UART interfaces can be implemented via hardware. The data transmission speed via UART interfaces reaches 115200 x 40 (4.5 Mbps).

UARTO can be used for communication. It supports flow control. Since UART1 features only data transmit signal (TX), it is usually used for printing log.

#### Note:

By default, UARTO outputs some printed information when the device is powered on and booting up. The baud rate of the printed information is relevant to the frequency of the external crystal oscillator. If the frequency of the crystal oscillator is 40 MHz, then the baud rate for printing is 115200; if the frequency of the crystal oscillator is 26 MHz, then the baud rate for printing is 74880. If the printed information exerts any influence on the functionality of the device, it is suggested to block the printing during the power-on period by changing (UOTXD, UORXD) to (MTDO, MTCK).

### 4.7. Pulse-Width Modulation (PWM)

ESP8285 has four PWM output interfaces. They can be extended by users themselves. The pin definitions of the PWM interfaces are defined as below.

Table 4-7. Pin Definitions of PWM

Pin Name	Pin Num	Ю	Function Name
MTDI	10	IO12	PWM0
MTDO	13	IO15	PWM1
MTMS	9	IO14	PWM2
GPIO4	16	IO4	PWM3

The functionality of PWM interfaces can be implemented via software programming. For example, in the LED smart light demo, the function of PWM is realized by interruption of the timer, the minimum resolution reaches as high as 44 ns. PWM frequency range is adjustable from 1000 µs to 10000 µs, i.e., between 100 Hz and 1 kHz. When the PWM



frequency is 1 kHz, the duty ratio will be 1/22727, and a resolution of over 14 bits will be achieved at 1 kHz refresh rate.

### 4.8. IR Remote Control

ESP8285 currently supports one infrared remote control interface. For detailed pin definitions, please see Table 4-8 below.

Table 4-8. Pin Definitions of IR Remote Control

Pin Name	Pin Num	Ю	Function Name
MTMS	9	IO14	IR TX
GPIO5	24	IO 5	IR Rx

The functionality of Infrared remote control interface can be implemented via software programming. NEC coding, modulation, and demodulation are supported by this interface. The frequency of modulated carrier signal is 38 kHz, while the duty ratio of the square wave is 1/3. The transmission range is around 1m which is determined by two factors: one is the maximum current drive output, the other is internal current-limiting resistance value in the infrared receiver. The larger the resistance value, the lower the current, so is the power, and vice versa.

### 4.9. ADC (Analog-to-Digital Converter)

ESP8285 is embedded with a 10-bit precision SAR ADC. TOUT (Pin6) is defined as below:

Table 4-9. Pin Definition of ADC

Pin Name	Pin Num	Function Name
TOUT	6	ADC Interface

The following two measurements can be implemented using ADC (Pin6). However, they cannot be implemented at the same time.

• Measure the power supply voltage of VDD3P3 (Pin3 and Pin4).

Hardware Design	TOUT must be floating.
RF Initialization Parameter	The 107th byte of <b>esp_init_data_default.bin</b> (0 ~ 127 bytes), vdd33_const must be set to 0xFF.
RF Calibration Process	Optimize the RF circuit conditions based on the testing results of VDD3P3 (Pin3 and Pin4).
User Programming	Use system_get_vdd33 instead of system_adc_read.

• Measure the input voltage of TOUT (Pin6).



Hardware Design	The input voltage range is 0 to 1.0 V when TOUT is connected to external circuit.
RF Initialization Parameter	The value of the 107th byte of <code>esp_init_data_default.bin</code> (0 ~ 127 bytes), <code>vdd33_const</code> must be set to the real power supply voltage of Pin3 and Pin4.  The unit and effective value range of <code>vdd33_const</code> is 0.1 V and 18 to 36, respectively, thus making the working power voltage range of ESP8285 between 1.8 V and 3.6 V.
RF Calibration Process	Optimize the RF circuit conditions based on the value of vdd33_const. The permissible error is ±0.2 V.
User Programming	Use system_adc_read instead of system_get_vdd33.

#### Notes:

esp\_init\_data\_default.bin is provided in SDK package which contains RF initialization parameters (0 ~ 127 bytes). The name of the 107th byte in esp\_init\_data\_default.bin is vdd33\_const, which is defined as below:

- When vdd33\_const = 0xff, the power voltage of Pin3 and Pin4 will be tested by the internal self-calibration process of ESP8285 itself. RF circuit conditions should be optimized according to the testing results.
- When 18 =< vdd33\_const =< 36, ESP8285 RF Calibration and optimization process is implemented via (vdd33\_const/10).
- When vdd33\_const < 18 or 36 < vdd33\_const < 255, vdd33\_const is invalid. ESP8285 RF Calibration and optimization process is implemented via the default value 3.3 V.



# 5. Electrical Specifications

### 5.1. Electrical Characteristics

Conditions Parameters Unit Min Typical Max IPC/JEDEC J-Maximum Soldering Temperature  $^{\circ}C$ 260 STD-020 V Working Voltage Value 2.7 3.3 3.6 VII -0.3 0.25 Vio  $V_{\text{IH}}$  $0.75\;V_{IO}$ 3.6 1/0  $V_{OL}$ 0.1 V<sub>IO</sub>  $V_{\text{OH}}$ 0.8 Vio  $I_{MAX}$ 12 mA Electrostatic Discharge (HBM) TAMB = 25 °C 2 ΚV Electrostatic Discharge (CDM) TAMB = 25 °C -0.5 ΚV

Table 5-1. Electrical Characteristics

#### **Notes on CHIP EN:**

The figure below shows ESP8266EX power-up and reset timing. Details about the parameters are listed in Table 5-2.

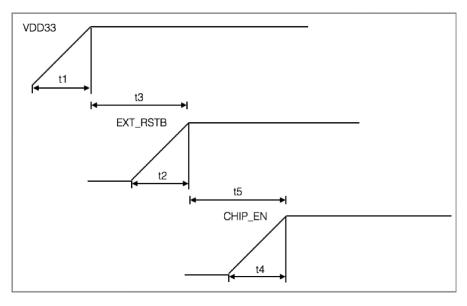


Figure 5-2. ESP8266EX Power-up and Reset Timing

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Table 5-2. Description of ESP8266EX Power-up and Reset Timing Parameters

	Description	MIN	MAX	Unit
t1	The rise-time of VDD33	10	2000	μs
t2	The rise-time of EXT_RSTB	0	2	ms
t3	EXT_RSTB goes high after VDD33.	0.1	-	ms
t4	The rise-time of CHIP_EN	0	2	ms
t5	CHIP_EN goes high after EXT_RSTB.	0.1	-	ms

### 5.2. RF Power Consumption

Unless otherwise specified, the power consumption measurements are taken with a  $3.0~\rm V$  supply at 25 °C of ambient temperature. All transmitters' measurements are based on a 50% duty cycle.

Table 5-2. Power Consumption

Parameters	Min	Typical	Max	Unit
TX 802.11 b, CCK 11 Mbps, P <sub>OUT</sub> = +19 dBm	-	197	-	mA
TX 802.11 g, OFDM 54Mbps, Pout= +15 dBm	-	147	-	mA
TX 802.11 n, MCS7, P <sub>OUT</sub> =+13 dBm	-	142	-	mA
Rx 802.11 b, 1024 bytes packet length , -80 dBm	-	73	-	mA
Rx 802.11 g, 1024 bytes packet length, -70 dBm	-	72	-	mA
Rx 802.11 n, 1024 bytes packet length, -65 dBm	-	72	-	mA



### 5.3. Wi-Fi Radio Characteristics

The following data are from tests conducted at room temperature, with a 3.3 V power supply.

Table 5-3. Wi-Fi Radio Characteristics

Parameters	Min	Typical	Max	Unit
Input frequency	2412	-	2483.5	MHz
Output power of PA for 72.2 Mbps	13	14	15	dBm
Output power of PA for 11b mode	18	19	20	dBm
Sensitivity				
DSSS, 1 Mbps	-	-97	-	dBm
CCK, 11 Mbps	-	-87	-	dBm
6 Mbps (1/2 BPSK)	-	-91	-	dBm
54 Mbps (3/4 64-QAM)	-	-74	-	dBm
HT20, MCS7 (65 Mbps, 72.2 Mbps)	-	-70	-	dBm
Adjacent Channel Rejection				
OFDM, 6 Mbps	-	31	-	dB
OFDM, 54 Mbps	-	14	-	dB
HT20, MCS0	-	31	-	dB
HT20, MCS7	-	13	-	dB



### 6.

# **Package Information**

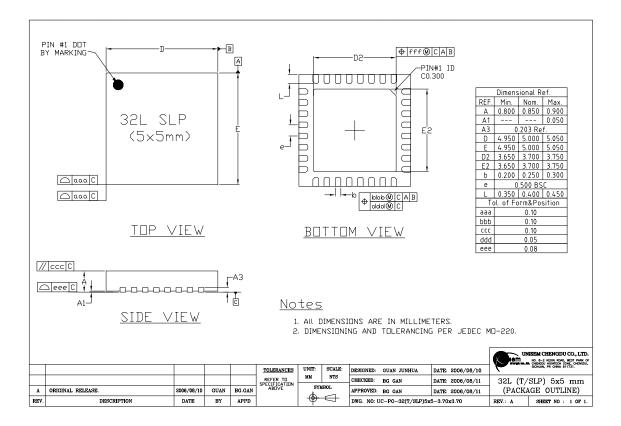


Figure 6-1. ESP8285 Package



# **Appendix - Pin List**

For detailed pin information, please see **ESP8266 Pin List**.

- Digital Die Pin List
- Buffer Sheet
- Register List
- Strapping List

#### Notes:

- INST\_NAME refers to the IO\_MUX REGISTER defined in **eagle\_soc.h**, for example MTDI\_U refers to PERIPHS\_IO\_MUX\_MTDI\_U.
- Net Name refers to the pin name in schematic.
- Function refers to the multifunction of each pin pad.
- Function number 1 ~ 5 correspond to FUNCTION 0 ~ 4 in SDK. For example, set MTDI to GPIO12 as follows.
  - #define FUNC\_GPI012 3 //defined in eagle\_soc.h
  - PIN\_FUNC\_SELECT(PERIPHS\_IO\_MUX\_MTDI\_U,FUNC\_GPI012)



# Appendix - Learning Resources

### II.1. Must-Read Documents

ESP-AT Instruction User Guide

Description: This document provides users with detailed information on what is ESP-AT, how to connect hardware, and how to download and flash AT firmware.

• ESP8266 SDK Getting Started Guide

Description: This document describes how to get started with ESP8266\_RTOS\_SDK, which is the official development framework for the ESP8266EX chip.

• ESP8266 Pin List

Description: This link directs you to a list containing the type and function of every ESP8266 pin.

ESP8266 Hardware Design Guideline

Description: This document provides a technical description of the ESP8266 series of products, including ESP8285, ESP-LAUNCHER and ESP-WROOM.

• ESP8266 Technical Reference

Description: This document provides an introduction to the interfaces integrated on ESP8266. Functional overview, parameter configuration, function description, application demos and other pieces of information are included.

• ESP8266 Hardware Resources

Description: This zip package includes manufacturing BOMs, schematics and PCB layouts of ESP8266 boards and modules.

FAQ

### II.2. Must-Have Resources

• ESP8266 SDKs

Description: This webpage provides links both to the latest version of the ESP8266 SDK and the older ones.

• ESP8266 Tools

Description: This webpage provides links to both the ESP8266 flash download tools and the ESP8266 performance evaluation tools.

• ESP8266 Apps



- ESP8266 Certification and Test Guide
- ESP8266 BBS
- ESP8266 Resources



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